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Specification							
Part	MC160080A6W-FPTLW						
Number:	1010100000, (000-1111200						
Version:							
Date:							
	Revision						
No. Date	e Description Item Page						

design • manufacture • supply

Revision History

VERSION	DATE	REVISED PAGE NO.	Note
0	2014/08/05		First issue



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1.General Specification

The Features is described as follow:

■ Module dimension: 100.0 x 54.0 x 14.6 (max.) mm

■ View area: 72.0 x 40.0 mm

Active area: 67.17 x 33.57 mm

■ Number of dots: 160 x 80

■ Dot size: 0.39 x 0.39 mm

■ Dot pitch: 0.42 x 0.42 mm

■ LCD type: FSTN Positive Transflective

■ Duty: 1/80

■ View direction: 6 o'clock

■ Backlight Type: LED, White

■ IC: RA6963

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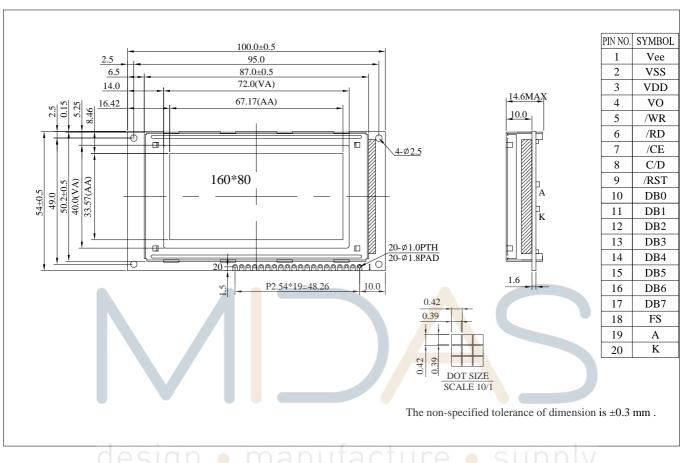
Midas LCD Part Number System

```
COG
                 132033
                                                                                  S
                                 Α
                                               6
                                                                                                 Т
                                                                                                        L
          2
                       3
                                 4
                                        5
                                               6
                                                      7
                                                             8
                                                                    9
                                                                                 10
                                                                                        11
                                                                                                12
                                                                                                       13
 1
                                                                                                              14
                                                                                                                      15
                                                                                                                             16
         =
                   MC: Midas Components
                   Blank: COB (chip on board) COG: chip on glass
                   No of dots
                                      (e.g. 240064 = 240 \times 64 \text{ dots})
                                                                             (e.g. 21605 = 2 \times 165 mm C.H.)
3
         =
         =
                   Series
4
         =
                   Series Variant:
                                       A to Z - see addendum
                                                          9: 9 o'clock
                                                                             12: 12 o'clock
         =
                   3: 3 o'clock
                                      6: 6 o'clock
6
                   S: Normal (0 to + 50 deg C) W: Wide temp. (-20 to + 70 deg C) X: Extended temp (-30 + 80 Deg C)
7
         =
8
                   Character Set
                   Blank: Standard (English/Japanese)
                   C: Chinese Simplified (Graphic Displays only)
                   CB: Chinese Big 5 (Graphic Displays only)
                   H: Hebrew
                   K: European (std) (English/German/French/Greek)
                   L: English/Japanese (special)
                   M: European (English/Scandinavian)
                   R: Cyrillic
                   W: European (English/Greek)
                   U: European (English/Scandinavian/Icelandic)
         =
                   Bezel Height (where applicable /available)
                                                       LED Connection
                              Top of Bezel to Top
                                                                               Array or
                                                      Common (via pins 1
                                    of PCB
                                                                               Edge Lit
                                                             and 2)
                             9.5mm / not
                    Blank
                                                        via pins 15+ 16-
                                                                                 Array
                             applicable
                    2
                             8.9 \; \mathrm{mm}
                                                            Common
                                                                                 Array
                    3
                             7.8 \; \mathrm{mm}
                                                            Separate
                                                                                 Array
                    4
                             7.8 \text{ mm}
                                                            Common
                                                                                 Array
                    5
                            9.5 \text{ mm}
                                                            Separate
                                                                                 Array
                    6
                             7~\mathrm{mm}
                                                            Common
                                                                                 Array
                    7
                             7~\mathrm{mm}
                                                            Separate
                                                                                 Array
                    8
                                                            Common
                             6.4 \text{ mm}
                                                                                 Edge
                             6.4 \text{ mm}
                                                            Separate
                                                                                 Edge
                             5.5 \text{ mm}
                                                            Common
                                                                                 Edge
                    A
                    В
                             5.5 \text{ mm}
                                                            Separate
                                                                                 Edge
                    D
                             6.0 mm
                                                            Separate
                                                                                 Edge
                    E
                             5.0mm
                                                            Separate
                                                                                 Edge
                    \mathbf{F}
                             4.7mm
                                                            Common
                                                                                 Edge
                    \mathbf{G}
                             3.7mm
                                                            Separate
                                                                                  \mathbf{EL}
                             7 \text{ mm}
                                                            Separate
                                                                                 Edge
                   T: TN S: STN B: STN Blue G: STN Grey F: FSTN F2: FFSTN V: VA (Vertically Aligned)
10
11
         =
                   P: Positive N: Negative
12
                   R: Reflective M: Transmissive T: Transflective
         =
                   Backlight: Blank: Reflective L: LED
13
         =
                   Backlight Colour: Y: Yellow-Green W: White B: Blue R: Red A: Amber O: Orange G: Green RGB: R.G.B.
14
                   Driver Chip:
                                      Blank: Standard I: I<sup>2</sup>C S: SPI T: Toshiba T6963C A: Avant SAP1024B
                                                                                                                      R: Raio RA6963
15
         =
                   Voltage Variant: e.g. 3 = 3v
16
         =
```

3.Interface Pin Function

Pin No.	Symbol	Level	Description
1	Vee	_	Negative Voltage Output
2	VSS	0V	Ground
3	VDD	_	Power supply for logic
4	V0	_	Power supply for LCD driver
5	/WR	H/L	Data write. Write data into RA6963 when /WR = L
6	/RD	H/L	Data read. Read data from RA6963 when RD = L
7	/CE	H/L	Chip enable the controller RA6963
8	/CD	H/L	Command/data read/write
9	/RST	L	Reset the LCM
10	DB0	H/L	Data bus line
11	DB1	H/L	Data bus line
12	DB2	H/L	Data bus line
13	DB3	H/L	Data bus line UT a CTUTE SUDDLY
14	DB4	H/L	Data bus line
15	DB5	H/L	Data bus line
16	DB6	H/L	Data bus line
17	DB7	H/L	Data bus line
18	FS	H/L	Pins for selection of font ;
19	Α		Power supply for B/L +

4.Contour Drawing

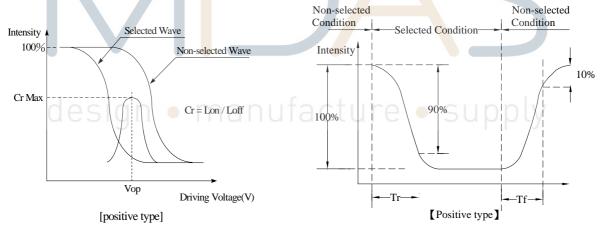


5.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	θ	CR≧2	0	_	30	ψ= 180°
	θ	CR≧2	0	_	60	ψ= 0°
	θ	CR≧2	0	_	45	ψ= 90°
	θ	CR≧2	0	_	45	ψ= 270°
Contrast Ratio	CR	_	_	5	_	_
Response Time	T rise	_	_	200	300	ms
	T fall		7	250	350	ms

Definition of Operation Voltage (Vop)

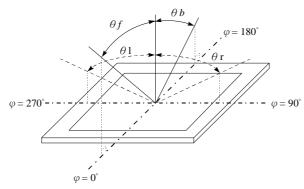
Definition of Response Time (Tr, Tf)



Conditions:

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

Definition of viewing angle(CR≥2)



6.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T _{OP}	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T _{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	V _{IN}	-0.3	_	V _{DD} +0.3	V
Supply Voltage For Logic	VDD-V _{SS}	-0.3	_	+7.0	V



7. Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V_{DD} - V_{SS}	_	3.0	_	5.5	V
Supply Voltage For LCD		Ta=-20°ℂ	_	_	_	V
Supply Voltage For LCD *Note	V_{DD} - V_0	Ta=25°ℂ	11.0	11.5	12.0	V
Note		Ta=70°C	_	_	_	V
Input High Volt.	V _{IH}	_	0.8V _{DD}	_	V_{DD}	V
Input Low Volt.	V _{IL}	_	0	_	0.2 V _{DD}	V
Output High Volt.	V _{OH}		VDD-0.3	_	V_{DD}	V
Output Low Volt.	V _{OL}	-	0	-	0.3	V
Supply Current	I _{DD}	-//	13.8	14.2	16.0	mA

^{*} Note: Please design the VOP adjustment circuit on customer's main board



8.Backlight Information

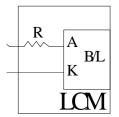
Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	_	64	80	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	v	_
Reverse Voltage	VR	_	_	5	v	_
Luminance (Without LCD)	IV	440	550	_	CD/M ²	ILED=64mA
LED Life Time (For Reference only)	-/1		50K			ILED=64mA 25℃,50-60%RH, (Note 1)
Color	White					

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.

LDrive from pin19, pin20



9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test						
Test Item	Content of Test	Test Condition	Note				
High Temperature storage	Endurance test applying the high storage temperature for a long time.	200hrs	2				
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30℃ 200hrs	1,2				
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs	·				
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 200hrs	1				
High Temperature/ Humidity storage	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2				
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation $-20^{\circ}C \qquad 25^{\circ}C \qquad 70^{\circ}C$ $30min \qquad 5min \qquad 30min$ 1 cycle	-20℃/ 70 ℃ 10 cycles					
design vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3				
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time					

Note1: No dew condensation to be observed.

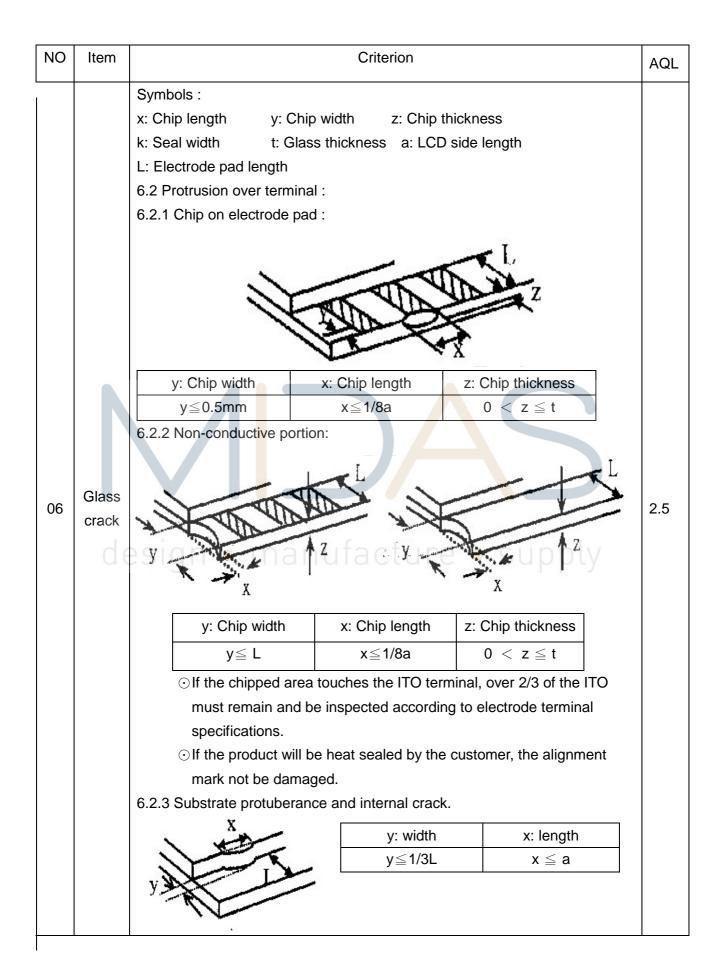
Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Inspection specification

NO	Item			Criterion		AQL
01	Electrical Testing	defect. 1.2 Missing chai 1.3 Display malf 1.4 No function	racter, do unction. or no display sumption e angle defect types.	lay. exceeds product sp		0.65
02	Black or white spots on LCD (display only)	2.1 White and black spots on display ≤0.25mm, no more than				2.5
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi = (x + y) / X$ $X = X$ 3.2 Line type : (A) $X = X$ $X = X$	Y nuf	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY Acceptable Q TY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are vi judge using blac specifications, n to find, must che specify direction	ck spot ot easy eck in	Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5

NO	Item	Criterion				
05	Scratches	Follow NO.3 LCD black	spots, white spots, cor	ntamination		
		Symbols Define: x: Chip length y: 0	spots, white spots, cor Chip width z: Chip Blass thickness a: LCl	thickness D side length	AQL	
06	Chipped glass	z: Chip thickness Z≦1/2t 1/2t <z≤2t< td=""><td>y: Chip width Not over viewing area Not exceed 1/3k</td><td>x: Chip length x≤1/8a x≤1/8a</td><td>2.5</td></z≤2t<>	y: Chip width Not over viewing area Not exceed 1/3k	x: Chip length x≤1/8a x≤1/8a	2.5	
	desi	 ○ If there are 2 or more 6.1.2 Corner crack:	chips, x is total length	of each chip.		
		z: Chip thickness Z≦1/2t		y: Chip width Not over viewing	x: Chip length x≤1/8a	
			area			
		1/2t < z ≦ 2t	Not exceed 1/3k	x≦1/8a		
		⊙ If there are 2 or more	chips, x is the total len	gth of each chip.		



NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
		 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 	2.5 2.5 0.65
10	PCB · COB	 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB 	2.5 0.65 0.65
		X * Y<=2mm2	2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
	General	pin must be present or look as if it cause the interface pin to	
12		sever. 12.6 The residual rosin or tin oil of soldering (component or chip	2.5
	appearance	component) is not burned into brown or black color.	2.5
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	3.00
	desia	12.12 Visual defect outside of VA is not considered to be rejection.	

11.Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) T @ have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9)T @ have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, T are have the right to modify the version.)

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12. Material List of Components for RoHs

1. T aaæ hereby declares that all of or part of products (with the mark

"#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.						

2.Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°€;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

13.Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5℃ and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

